ASSOCIATION CONNECTING	© Co	pyright 2005. IPC, Bannoc nternational and Pan-Americ	kburn, Illinois	. All rights reserv	tion with lower		he declarati	on enco		ver level mater	ials for which	the item is an assembly the manufacturer has is declaration.			
1752-2 1.1		Web Site for Informat ://www.ipc.org/IPC-1		-1752 Standa	rd	Form Typ Distribute		Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Informa							
Supplier Information															
Company Name * Company Unique ID				Unique ID Au	Response Date *			Response Doo	ument ID						
SEMTECH CORPORATION		Semtech Corporation	ı			2017-02-23									
Contact Name *		Title - Contact		Phone - Con	tact *	Email - Contact *					A (1 1 1	D			
Jeffrey Gabrielson		Quality Assurance C	ustomer Se	(805) 498-21	11	jgabrielson@semtech.com			Duplicate	e Contact -:	> Authorized	Representative			
Authorized Representative *		Title - Representative	Э	Phone - Representative *		Email - Representative *			Supplier Comments or URL for Additional Information						
Jeffrey Gabrielson		Quality Assurance C	ustomer S	€805) 498-21	11	jgabrielson	@semtech	.com							
Requester Item Number		Mfr Item Number		Mfr Item Name	•	Effective Date	Version	Manuf	acturing Site	Weight *	UOM	Unit Type			
		SC4150HISTRT		NEG VOLT H	OT SWAP CONTI	२		Malay	sia	74.16	mg	Each			
Alternate Recommen	endation						Alternat	e Item C	omments						
Manufacturing Proc	ess In	formation					l								
Terminal Plating / Grid Arra	y Mater	ial	Terminal Ba	ase Alloy	J-STD-020 MSL Ra	ting Peak F	Process Body	y Tempe	rature Max Time	at Peak Temp	erature Numb	er of Reflow Cycles			
Matte Tin (Sn) CU Alloy				1	260 (;	30 sec	conds 3					
Comments SC4150HISTRT is REA	CH-co	mpliant product, per	· EU Regu	lation EC190	7/2006 to include	recent addi	tion of SVI	HC can	didate list of s	ubstances in	January 20	17.			

Save the fields in this form to a file	Export Data	Import fields from a file into this form	Import Data	Clear all of the fields on this form	Reset Form	Lock the fields on this form to prevent chan	Look Cumption Fields				
RoHS Material Composition Declaration Declaration Type * Detailed											
		limit of 0.1% by mass (100 thers (PBDE) and quantity	, .				ominated Biphenyls (PBB),				
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2002/95/EC and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalent chromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance in excess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration	n * 1 - Item(s) does not contain	RoHS restricted substances per th	he definition above			Supplier Acceptance *	Accepted				
	declared item does not cont Il applicable exemptions.	ain RoHS restricted substanc	es per the definition a	bove except for defined	RoHS exemptions, then s	select the corresponding re	esponse in the RoHS Declaration				
Declaration Si	gnature										
		C 1 1 11 C (1 1)				T 1: 10 11 1 4	D' i ll i				

Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.

Supplier Digital Signature

Homogeneous Material Composition Declaration for Electronic Products

Subltem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Line Functions: +I Inserts a New Item /SubItem +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

	Item/SubItem		Homogeneous	Weight	Unit of		Level	Substance Category			Substance	ce CAS	Exempt	Woight	Unit of	Tolerance		- PPM
	Name		Material	weight	Measure			Substance Category			Substance				Measure	-	+	
+1 -1	SILICON CHIP	+M -M	Silicon Chip	2.63	mg	+C -C	Supplier		+S	-s	Silicon (Si)	7440-21-3		2.63	mg		;	36,057
		_							+S	-s					mg			
+1 -1	LEAD FRAME, SO	+М-М	AG plated Cu C1	24.2116	mg	+C -C	Supplier		+S	-s	Copper (Cu)	7440-50-8		23.5839	mg			318,01
			•			+C -C	A	Lead/Lead Compound	+S	-s	Lead	7439-92-1		0.0073	mg		·	98.14
						+C -C	Supplier		+S	-s	Iron (Fe)	7439-89-6		0.5701	mg		-	7,687.5
									+S	-s	Phosphorous (P)	7723-14-0		0.0199	mg			269.23
									+S	-s	Zinc (Zn)	7440-66-6		0.0303	mg			408.91
		+M -M	Silver Plating	0.0485	mg	+C -C	Supplier		+S	-s	Silver (Ag)	7440-22-4	•	0.0485	mg			664.26
+I -I	WIRE BONDING	+M -M	Gold Wire	0.3	mg	+C -C	Supplier		+S	-s	Gold (Au)	7440-57-5		0.3	mg			4,044.9
+1 -1	DIE ATTACHED MA	+м -м	84-1LMISR4	1.13	mg	+C -C	Supplier		+S	-s	Epoxy Resin	Proprietary		0.1695	mg		:	2,285.6
									+S	-s	Silver (Ag)	7440-22-4		0.8758	mg			11,808
									+S	-s	Aromatic Amine	Proprietary		0.0622	mg			838.05
+I -I	MOLDING COMPO	+M -M	EME-G600C	44.38	mg	+C -C	Supplier		+S	-s	Silica Fused	60676-86-0	•	37.723	mg		ł	508,67
									+S	-s	Epoxy Resins	Proprietary		2.219	mg			29,921
									+S	-s	Cresol Novolac	29690-82-2		0.8876	mg			11,968
									+S	-s	Phenol Resin	Proprietary		2.219	mg			29,921
									+S	-s	Carbon Black	1333-86-4		0.1331	mg			1,795.3
+ -	PLATING FINISH	+M -M	Tin Alloy	1.46	mg	+C -C	Supplier		+S	-s	Tin (Sn)	7440-31-5	<u> </u>	1.46	mg			19,685
	4						•		+S	-s	Others			0.0002	mg			1.97